

Microsemi Corporation

November 14, 2016

Product Discontinuance Notification (PDN) No: PDN 17006**Subject:** Last time buy for Mixed-Signal Power Manager Daughter Card Kit (MPM-DC-KIT).**Description:** Microsemi is announcing the discontinuance of MPM-DC-KIT.

This kit enables designers to evaluate power management solutions in hardware for SmartFusion® FPGA, included on SmartFusion Evaluation Kit and SmartFusion Development Kit.

Reason for Discontinuance: Digital Mixed-Signal Power Manager (DMPM) Daughter Card Kit has superior functionalities and capabilities than MPM Daughter Card Kit (MPM-DC-KIT). This kit allows designers to understand the features and capabilities of the full MPM solution before designing their own PCB. So, going forward it is recommended to order DMPM Daughter Card Kit for new designs.

Customer Impact: Small quantities remain in inventory and will continue to be sold until the stock is depleted. Orders will be supported on a first-come-first-serve basis. Orders for these products will be non-cancelable and non-returnable.

For information on conversion to alternate parts, contact your local [Microsemi Sales Office](#).

Replacement Parts: Comparable alternate to this will be DMPM Daughter Card Kit.

Last Order Date: November 30, 2016 (or until inventory depletes)

Last Shipment Date: Within 30 days of last order

All orders must be booked as non-cancelable non-returnable (NCNR) by the last order date. Although Microsemi will attempt to accommodate all requirements, it is highly recommended that orders be placed as far in advance of the order deadline as possible. Acceptance of last-time-buy orders is subject to product availability and at the discretion of Microsemi Corporation. Every effort will be made to fulfill these orders. The inventory is limited, so orders will be taken on a first-come, first-served basis.

Products Affected by this Discontinuance:

Old Kit	New Kit
MPM-DC-KIT	DMPM-DC-KIT

Microsemi Corporation

One Enterprise, Aliso Viejo, CA 92656 USA

Within the USA: +1 (800) 713-4113 Outside the USA: +1 (949) 380-6100 Sales: +1 (949) 380-6136 Fax: +1 (949) 215-4996 E-mail: sales.support@microsemi.com, www.microsemi.com

MSC-F-0004 Rev 5

Do Not Distribute Outside Microsemi Without Written Permission

Page 1 of 2

Contact Information: Microsemi SoC Product Group

If you have any questions, contact Microsemi's SoC technical support at soc_tech@microsemi.com.

Regards,
Microsemi Corporation

Any projected dates in this notification are based on the most current product information at the time this PDN is being issued, but they may change due to unforeseen circumstances. For the latest schedule and any other information, please contact your local Microsemi Sales Office, the factory contact shown above, or your local distributor.

This PDN is confidential and proprietary information of Microsemi and is intended only for distribution by Microsemi to its customers, for customers' use only. It must not be copied or provided to any third party without Microsemi's prior written consent.



Microsemi Corporate Headquarters
One Enterprise, Aliso Viejo, CA 92656 USA
Within the USA: +1 (800) 713-4113
Outside the USA: +1 (949) 380-6100
Fax: +1 (949) 215-4996
Email: sales.support@microsemi.com
www.microsemi.com

©2016 Microsemi Corporation. All rights reserved. Microsemi and the Microsemi logo are registered trademarks of Microsemi Corporation. All other trademarks and service marks are the property of their respective owners.

Microsemi makes no warranty, representation, or guarantee regarding the information contained herein or the suitability of its products and services for any particular purpose, nor does Microsemi assume any liability whatsoever arising out of the application or use of any product or circuit. The products sold hereunder and any other products sold by Microsemi have been subject to limited testing and should not be used in conjunction with mission-critical equipment or applications. Any performance specifications are believed to be reliable but are not verified, and Buyer must conduct and complete all performance and other testing of the products, alone and together with, or installed in, any end-products. Buyer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the Buyer's responsibility to independently determine suitability of any products and to test and verify the same. The information provided by Microsemi hereunder is provided "as is, where is" and with all faults, and the entire risk associated with such information is entirely with the Buyer. Microsemi does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other IP rights, whether with regard to such information itself or anything described by such information. Information provided in this document is proprietary to Microsemi, and Microsemi reserves the right to make any changes to the information in this document or to any products and services at any time without notice.

About Microsemi

Microsemi Corporation (Nasdaq: MSCC) offers a comprehensive portfolio of semiconductor and system solutions for aerospace & defense, communications, data center and industrial markets. Products include high-performance and radiation-hardened analog mixed-signal integrated circuits, FPGAs, SoCs and ASICs; power management products; timing and synchronization devices and precise time solutions, setting the world's standard for time; voice processing devices; RF solutions; discrete components; enterprise storage and communication solutions; security technologies and scalable anti-tamper products; Ethernet solutions; Power-over-Ethernet ICs and midspans; as well as custom design capabilities and services. Microsemi is headquartered in Aliso Viejo, Calif., and has approximately 4,800 employees globally. Learn more at www.microsemi.com.

MSC-F-0004 Rev 5

Do Not Distribute Outside Microsemi Without Written Permission

Page 2 of 2